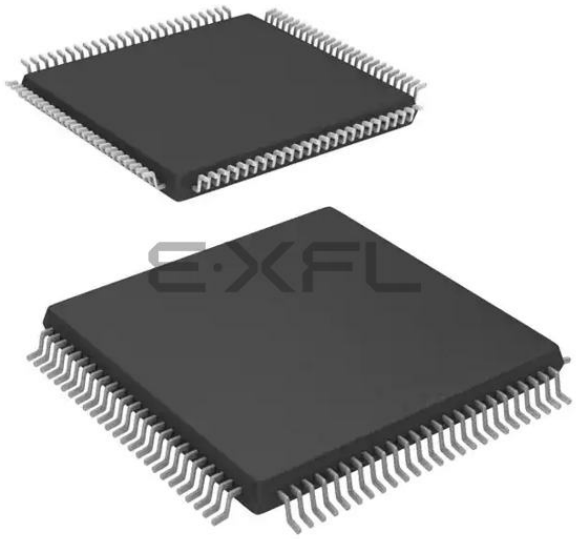
Silicon Labs - EFM32GG11B820F2048IQ100-AR Datasheet



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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	ARM® Cortex®-M4
Core Size	32-Bit Single-Core
Speed	72MHz
Connectivity	CANbus, EBI/EMI, Ethernet, I²C, IrDA, LINbus, MMC/SD/SDIO, QSPI, SmartCard, SPI, UART/USART, USB
Peripherals	Brown-out Detect/Reset, DMA, LCD, POR, PWM, WDT
Number of I/O	80
Program Memory Size	2MB (2M x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.8V
Data Converters	A/D 16x12b SAR; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TQFP
Supplier Device Package	100-TQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/efm32gg11b820f2048iq100-ar

3.4.2 Internal and External Oscillators

The EFM32GG11 supports two crystal oscillators and fully integrates five RC oscillators, listed below.

- A high frequency crystal oscillator (HFXO) with integrated load capacitors, tunable in small steps, provides a precise timing reference for the MCU. Crystal frequencies in the range from 4 to 50 MHz are supported. An external clock source such as a TCXO can also be applied to the HFXO input for improved accuracy over temperature.
- A 32.768 kHz crystal oscillator (LFXO) provides an accurate timing reference for low energy modes.
- An integrated high frequency RC oscillator (HFRCO) is available for the MCU system. The HFRCO employs fast startup at minimal energy consumption combined with a wide frequency range. When crystal accuracy is not required, it can be operated in free-running mode at a number of factory-calibrated frequencies. A digital phase-locked loop (DPLL) feature allows the HFRCO to achieve higher accuracy and stability by referencing other available clock sources such as LFXO and HFXO.
- An integrated auxilliary high frequency RC oscillator (AUXHFRCO) is available for timing the general-purpose ADC and the Serial Wire Viewer port with a wide frequency range.
- An integrated auxilliary high frequency RC oscillator (USHFRCO) is available for timing the USB, SDIO and QSPI peripherals. The USHFRCO can be syncronized to the host's USB clock to allow the USB to operate in device mode without the additional cost of an external crystal.
- An integrated low frequency 32.768 kHz RC oscillator (LFRCO) can be used as a timing reference in low energy modes, when crystal accuracy is not required.
- An integrated ultra-low frequency 1 kHz RC oscillator (ULFRCO) is available to provide a timing reference at the lowest energy consumption in low energy modes.

3.5 Counters/Timers and PWM

3.5.1 Timer/Counter (TIMER)

TIMER peripherals keep track of timing, count events, generate PWM outputs and trigger timed actions in other peripherals through the PRS system. The core of each TIMER is a 16-bit counter with up to 4 compare/capture channels. Each channel is configurable in one of three modes. In capture mode, the counter state is stored in a buffer at a selected input event. In compare mode, the channel output reflects the comparison of the counter to a programmed threshold value. In PWM mode, the TIMER supports generation of pulse-width modulation (PWM) outputs of arbitrary waveforms defined by the sequence of values written to the compare registers, with optional dead-time insertion available in timer unit TIMER_0 only.

3.5.2 Wide Timer/Counter (WTIMER)

WTIMER peripherals function just as TIMER peripherals, but are 32 bits wide. They keep track of timing, count events, generate PWM outputs and trigger timed actions in other peripherals through the PRS system. The core of each WTIMER is a 32-bit counter with up to 4 compare/capture channels. Each channel is configurable in one of three modes. In capture mode, the counter state is stored in a buffer at a selected input event. In compare mode, the channel output reflects the comparison of the counter to a programmed threshold value. In PWM mode, the WTIMER supports generation of pulse-width modulation (PWM) outputs of arbitrary waveforms defined by the sequence of values written to the compare registers, with optional dead-time insertion available in timer unit WTIMER_0 only.

3.5.3 Real Time Counter and Calendar (RTCC)

The Real Time Counter and Calendar (RTCC) is a 32-bit counter providing timekeeping in all energy modes. The RTCC includes a Binary Coded Decimal (BCD) calendar mode for easy time and date keeping. The RTCC can be clocked by any of the on-board oscillators with the exception of the AUXHFRCO, and it is capable of providing system wake-up at user defined instances. The RTCC includes 128 bytes of general purpose data retention, allowing easy and convenient data storage in all energy modes down to EM4H.

3.5.4 Low Energy Timer (LETIMER)

The unique LETIMER is a 16-bit timer that is available in energy mode EM2 Deep Sleep in addition to EM1 Sleep and EM0 Active. This allows it to be used for timing and output generation when most of the device is powered down, allowing simple tasks to be performed while the power consumption of the system is kept at an absolute minimum. The LETIMER can be used to output a variety of waveforms with minimal software intervention. The LETIMER is connected to the Real Time Counter and Calendar (RTCC), and can be configured to start counting on compare matches from the RTCC.

3.5.5 Ultra Low Power Wake-up Timer (CRYOTIMER)

The CRYOTIMER is a 32-bit counter that is capable of running in all energy modes. It can be clocked by either the 32.768 kHz crystal oscillator (LFXO), the 32.768 kHz RC oscillator (LFRCO), or the 1 kHz RC oscillator (ULFRCO). It can provide periodic Wakeup events and PRS signals which can be used to wake up peripherals from any energy mode. The CRYOTIMER provides a wide range of interrupt periods, facilitating flexible ultra-low energy operation.

3.12 Configuration Summary

The features of the EFM32GG11 are a subset of the feature set described in the device reference manual. The table below describes device specific implementation of the features. Remaining modules support full configuration.

Table 3.2. Configuration Summary

Module	Configuration	Pin Connections
USART0	IrDA, SmartCard	US0_TX, US0_RX, US0_CLK, US0_CS
USART1	I^2S, SmartCard	US1_TX, US1_RX, US1_CLK, US1_CS
USART2	IrDA, SmartCard, High-Speed	US2_TX, US2_RX, US2_CLK, US2_CS
USART3	I^2S, SmartCard	US3_TX, US3_RX, US3_CLK, US3_CS
USART4	I^2S, SmartCard	US4_TX, US4_RX, US4_CLK, US4_CS
USART5	SmartCard	US5_TX, US5_RX, US5_CLK, US5_CS
TIMER0	with DTI	TIM0_CC[2:0], TIM0_CDTI[2:0]
TIMER1	-	TIM1_CC[3:0]
TIMER2	with DTI	TIM2_CC[2:0], TIM2_CDTI[2:0]
TIMER3	-	TIM3_CC[2:0]
TIMER4	with DTI	TIM4_CC[2:0], TIM4_CDTI[2:0]
TIMER5	-	TIM5_CC[2:0]
TIMER6	with DTI	TIM6_CC[2:0], TIM6_CDTI[2:0]
WTIMER0	with DTI	WTIM0_CC[2:0], WTIM0_CDTI[2:0]
WTIMER1	-	WTIM1_CC[3:0]
WTIMER2	-	WTIM2_CC[2:0]
WTIMER3	-	WTIM3_CC[2:0]

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Start up time	t_{IDAC_SU}	Output within 1% of steady state value	—	5	—	µs
Settling time, (output settled within 1% of steady state value),	t_{IDAC_SETTLE}	Range setting is changed	—	5	—	µs
		Step value is changed	—	1	—	µs
Current consumption[2]	I_{IDAC}	EM0 or EM1 Source mode, excluding output current, Across operating temperature range	—	11	TBD	µA
		EM0 or EM1 Sink mode, excluding output current, Across operating temperature range	—	13	TBD	µA
		EM2 or EM3 Source mode, excluding output current, T = 25 °C	—	0.05	—	µA
		EM2 or EM3 Sink mode, excluding output current, T = 25 °C	—	0.07	—	µA
		EM2 or EM3 Source mode, excluding output current, T ≥ 85 °C	—	11	—	µA
		EM2 or EM3 Sink mode, excluding output current, T ≥ 85 °C	—	13	—	µA
Output voltage compliance in source mode, source current change relative to current sourced at 0 V	I_{COMP_SRC}	RANGESEL1=0, output voltage = min(V_{IOVDD}, V_{AVDD}[2]-100 mv)	—	0.11	—	%
		RANGESEL1=1, output voltage = min(V_{IOVDD}, V_{AVDD}[2]-100 mV)	—	0.06	—	%
		RANGESEL1=2, output voltage = min(V_{IOVDD}, V_{AVDD}[2]-150 mV)	—	0.04	—	%
		RANGESEL1=3, output voltage = min(V_{IOVDD}, V_{AVDD}[2]-250 mV)	—	0.03	—	%
Output voltage compliance in sink mode, sink current change relative to current sunk at IOVDD	I_{COMP_SINK}	RANGESEL1=0, output voltage = 100 mV	—	0.29	—	%
		RANGESEL1=1, output voltage = 100 mV	—	0.27	—	%
		RANGESEL1=2, output voltage = 150 mV	—	0.12	—	%
		RANGESEL1=3, output voltage = 250 mV	—	0.03	—	%

Note:

1. In IDAC_CURPROG register.
2. The IDAC is supplied by either AVDD, DVDD, or IOVDD based on the setting of ANASW in the EMU_PWRCTRL register and PWRSEL in the IDAC_CTRL register. Setting PWRSEL to 1 selects IOVDD. With PWRSEL cleared to 0, ANASW selects between AVDD (0) and DVDD (1).

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Supply current, continuous conversions, WARMUP-MODE=KEEPCSENWARM	I_{CSEN_ACTIVE}	SAR or Delta Modulation conversions of 33 pF capacitor, CS0CG=0 (Gain = 10x), always on	—	90.5	—	µA
HFPERCLK supply current	$I_{CSEN\_HFPERCLK}$	Current contribution from HFPERCLK when clock to CSEN block is enabled.	—	2.25	—	µA/MHz

Note:

1. Current is specified with a total external capacitance of 33 pF per channel. Average current is dependent on how long the module is actively sampling channels within the scan period, and scales with the number of samples acquired. Supply current for a specific application can be estimated by multiplying the current per sample by the total number of samples per period (total_current = single_sample_current * (number_of_channels * accumulation)).

SDIO SDR Mode Timing

Timing is specified for route location 0 at 1.8 V IOVDD with voltage scaling disabled. Slew rate for SD_CLK set to 7, all other GPIO set to 6, DRIVESTRENGTH = STRONG for all pins. SDIO_CTRL_TXDLYMUXSEL = 0. Loading between 5 and 10 pF on all pins or between 10 and 40 pF on all pins.

Table 4.48. SDIO SDR Mode Timing (Location 0)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Clock frequency during data transfer	F_{SD_CLK}	Using HFRCO, AUXHFRCO, or USHFRCO	—	—	20	MHz
		Using HFXO	—	—	TBD	MHz
Clock low time	t_{WL}	Using HFRCO, AUXHFRCO, or USHFRCO	22.6	—	—	ns
		Using HFXO	TBD	—	—	ns
Clock high time	t_{WH}	Using HFRCO, AUXHFRCO, or USHFRCO	22.6	—	—	ns
		Using HFXO	TBD	—	—	ns
Clock rise time	t_R		0.99	4.68	—	ns
Clock fall time	t_F		0.90	3.64	—	ns
Input setup time, CMD, DAT[0:3] valid to SD_CLK	t_{ISU}		8	—	—	ns
Input hold time, SD_CLK to CMD, DAT[0:3] change	t_{IH}		1.5	—	—	ns
Output delay time, SD_CLK to CMD, DAT[0:3] valid	t_{ODLY}		0	—	35	ns
Output hold time, SD_CLK to CMD, DAT[0:3] change	t_{OH}		0.8	—	—	ns

4.2.2 DC-DC Converter

Default test conditions: CCM mode, LDCDC = 4.7 µH, CDCDC = 4.7 µF, VDCDC_I = 3.3 V, VDCDC_O = 1.8 V, FDCDC_LN = 7 MHz

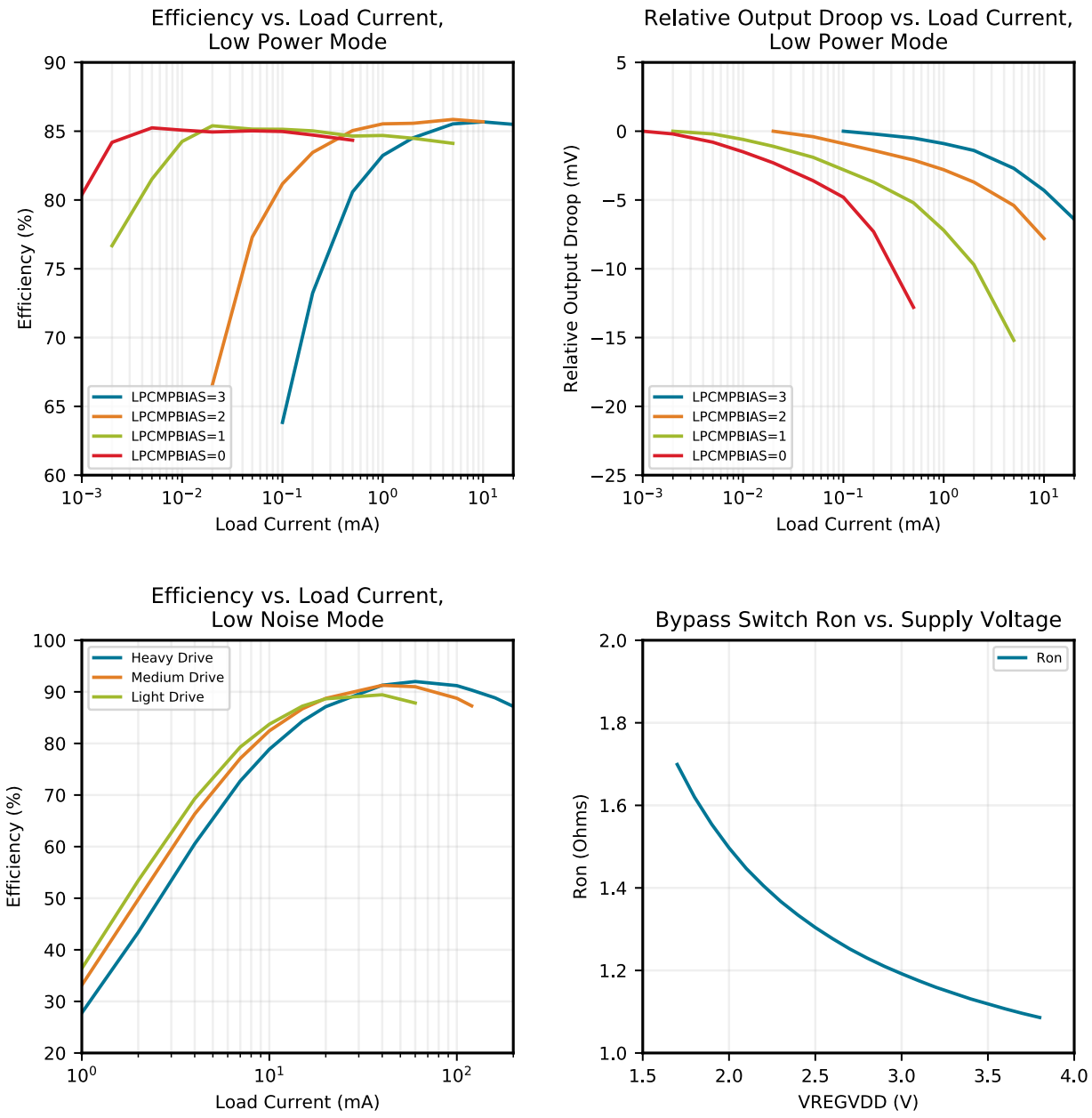

Figure 4.29. DC-DC Converter Typical Performance Characteristics

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PA15	B1	GPIO	PE14	B2	GPIO
PE12	B3	GPIO	PE8	B4	GPIO
PD11	B5	GPIO	PD9	B6	GPIO
PF8	B7	GPIO	PF6	B8	GPIO
PF14	B9	GPIO (5V)	PF12	B10	GPIO
PF2	B11	GPIO	PF0	B12	GPIO (5V)
PC14	B13	GPIO (5V)	VREGO	B14	Decoupling for 5 V regulator and regulator output. Power for USB PHY in USB-enabled OPNs
PA1	C1	GPIO	PA0	C2	GPIO
PD13	C3	GPIO (5V)	PE10	C4	GPIO
PI8	C5	GPIO (5V)	PI7	C6	GPIO (5V)
PI6	C7	GPIO (5V)	PF5	C8	GPIO
PF15	C9	GPIO (5V)	PF4	C10	GPIO
PF3	C11	GPIO	PC13	C12	GPIO (5V)
PC12	C13	GPIO (5V)	VREGI	C14	Input to 5 V regulator.
PA3	D1	GPIO	PA2	D2	GPIO
PD14	D3	GPIO (5V)	PC11	D12	GPIO (5V)
PC10	D13	GPIO (5V)	PC9	D14	GPIO (5V)
PA5	E1	GPIO	PA4	E2	GPIO
PD15	E3	GPIO (5V)	IOVDD1	E6	Digital IO power supply 1.
VSS	E7 E8 G5 G7 G8 G10 H5 H7 H8 H10 K7 K8	Ground	IOVDD0	E9 F10 J5 J10 K6 K9	Digital IO power supply 0.
PC8	E12	GPIO (5V)	PI5	E13	GPIO (5V)
PI4	E14	GPIO (5V)	PG0	F1	GPIO (5V)
PA6	F2	GPIO	PG1	F3	GPIO (5V)
IOVDD2	F5	Digital IO power supply 2.	PI3	F12	GPIO (5V)
PI2	F13	GPIO (5V)	PI1	F14	GPIO (5V)
PG3	G1	GPIO (5V)	PG4	G2	GPIO (5V)
PG2	G3	GPIO (5V)	PE7	G12	GPIO
PI0	G13	GPIO (5V)	DECOUPLE	G14	Decouple output for on-chip voltage regulator. An external decoupling capacitor is required at this pin.

5.4 EFM32GG11B5xx in BGA120 Device Pinout

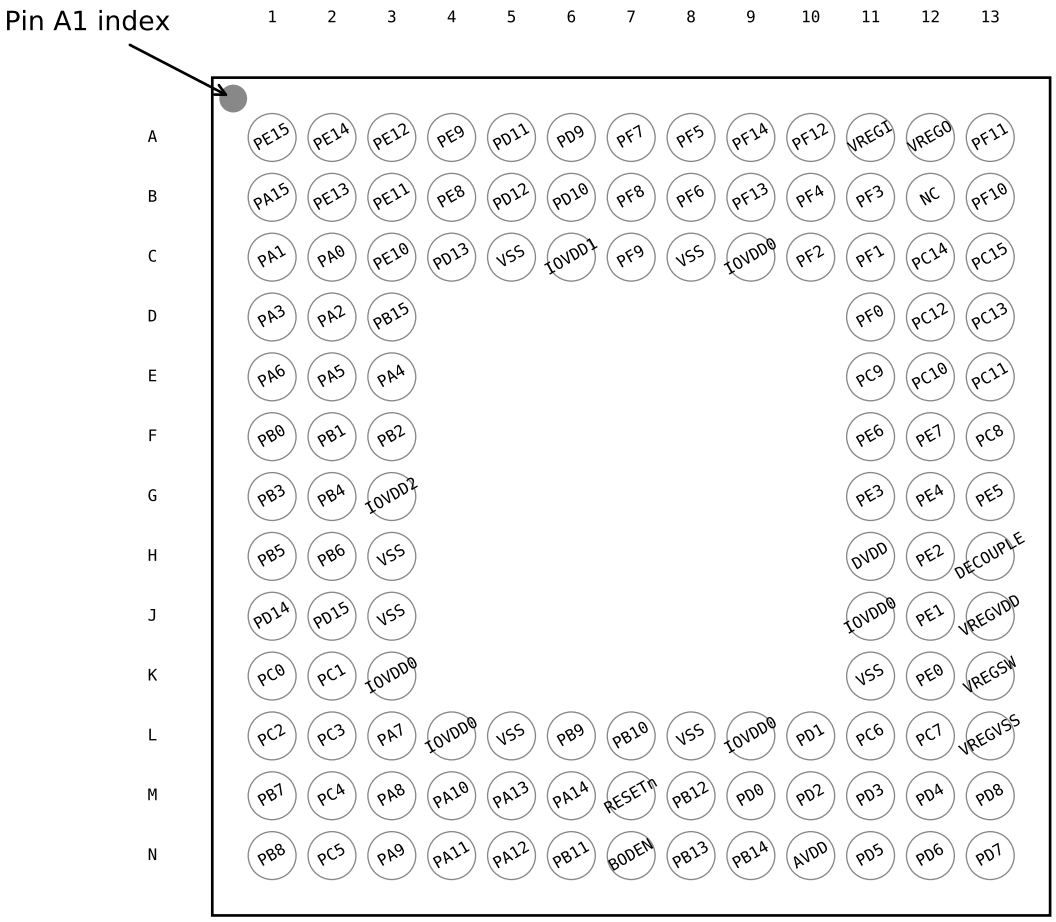

Figure 5.4. EFM32GG11B5xx in BGA120 Device Pinout

The following table provides package pin connections and general descriptions of pin functionality. For detailed information on the supported features for each GPIO pin, see 5.20 GPIO Functionality Table or 5.21 Alternate Functionality Overview.

Table 5.4. EFM32GG11B5xx in BGA120 Device Pinout

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PE15	A1	GPIO	PE14	A2	GPIO
PE12	A3	GPIO	PE9	A4	GPIO
PD11	A5	GPIO	PD9	A6	GPIO
PF7	A7	GPIO	PF5	A8	GPIO
PF14	A9	GPIO (5V)	PF12	A10	GPIO
VREGI	A11	Input to 5 V regulator.	VREGO	A12	Decoupling for 5 V regulator and regulator output. Power for USB PHY in USB-enabled OPNs

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PB2	11	GPIO	PB3	12	GPIO
PB4	13	GPIO	PB5	14	GPIO
PB6	15	GPIO	VSS	16 32 59 83	Ground
PC0	18	GPIO (5V)	PC1	19	GPIO (5V)
PC2	20	GPIO (5V)	PC3	21	GPIO (5V)
PC4	22	GPIO	PC5	23	GPIO
PB7	24	GPIO	PB8	25	GPIO
PA7	26	GPIO	PA8	27	GPIO
PA9	28	GPIO	PA10	29	GPIO
PA11	30	GPIO	PA12	33	GPIO (5V)
PA13	34	GPIO (5V)	PA14	35	GPIO
RESETn	36	Reset input, active low. To apply an external reset source to this pin, it is required to only drive this pin low during reset, and let the internal pull-up ensure that reset is released.	PB9	37	GPIO (5V)
PB10	38	GPIO (5V)	PB11	39	GPIO
PB12	40	GPIO	AVDD	41	Analog power supply.
PB13	42	GPIO	PB14	43	GPIO
PD0	45	GPIO (5V)	PD1	46	GPIO
PD2	47	GPIO (5V)	PD3	48	GPIO
PD4	49	GPIO	PD5	50	GPIO
PD6	51	GPIO	PD7	52	GPIO
PD8	53	GPIO	PC7	54	GPIO
VREGVSS	55	Voltage regulator VSS	VREGSW	56	DCDC regulator switching node
VREGVDD	57	Voltage regulator VDD input	DVDD	58	Digital power supply.
DECOUPLE	60	Decouple output for on-chip voltage regulator. An external decoupling capacitor is required at this pin.	PE1	61	GPIO (5V)
PE2	62	GPIO	PE3	63	GPIO
PE4	64	GPIO	PE5	65	GPIO
PE6	66	GPIO	PE7	67	GPIO
PC8	68	GPIO (5V)	PC9	69	GPIO (5V)
PC10	70	GPIO (5V)	PC11	71	GPIO (5V)
VREGI	72	Input to 5 V regulator.	VREGO	73	Decoupling for 5 V regulator and regulator output. Power for USB PHY in USB-enabled OPNs
PF10	74	GPIO (5V)	PF11	75	GPIO (5V)
PF0	76	GPIO (5V)	PF1	77	GPIO (5V)

GPIO Name	Pin Alternate Functionality / Description				
	Analog	EBI	Timers	Communication	Other
PD13		EBI_ARDY #1	TIM2_CDTI0 #1 TIM3_CC1 #6 WTIM0_CC1 #1	ETH_MDIO #1 US4_CTS #1 US5_CLK #1	ETM_TD1 #1
PI15				CAN1_TX #7 US3_CS #5	
PI14				CAN1_RX #7 US3_CLK #5	
PI13				CAN0_TX #7 US3_RX #5	
PI12				CAN0_RX #7 US3_TX #5	
PI10		EBI_A15 #2	TIM4_CC2 #3	US4_CTS #3	
PI7		EBI_A12 #2	TIM1_CC1 #7 TIM4_CC2 #2 WTIM3_CC1 #5	US4_RX #3	
PF15	BUSCY BUSDX		TIM1_CC2 #6 TIM4_CC2 #1 WTIM3_CC2 #7	US5_TX #2 I2C2_SDA #5	
PF12	BUSDY BUSCX	EBI_NANDREn #5	TIM4_CC2 #0 TIM1_CC3 #5 TIM5_CC0 #7 WTIM3_CC2 #6	US5_CS #2 I2C2_SCL #3 USB_ID	
PF4	BUSDY BUSCX LCD_SEG2	EBI_WEn #0 EBI_WEn #5	TIM4_CC1 #0 TIM0_CDTI1 #2 TIM1_CC2 #5 WTIM3_CC1 #6	US1_RTS #2 I2C2_SDA #3	PRS_CH1 #1
PC15	VDAC0_OUT1ALT / OPA1_OUTALT #3 BUSACMP1Y BUSACMP1X	EBI_NANDREn #4	TIM0_CDTI2 #1 TIM1_CC2 #0 WTIM0_CC0 #4 LETIM0_OUT1 #5	US0_CLK #3 US1_CLK #3 US3_RTS #3 U0_RX #3 U1_RTS #0 LEU0_RX #5 I2C2_SCL #1	LES_CH15 PRS_CH1 #2 ACMP3_O #1 DBG_SWO #1
PC14	VDAC0_OUT1ALT / OPA1_OUTALT #2 BUSACMP1Y BUSACMP1X	EBI_NANDWEn #4	TIM0_CDTI1 #1 TIM1_CC1 #0 TIM1_CC3 #4 TIM5_CC0 #6 WTIM3_CC0 #3 LETIM0_OUT0 #5 PCNT0_S1IN #0	US0_CS #3 US1_CS #3 US2_RTS #3 US3_CS #2 U0_TX #3 U1_CTS #0 LEU0_TX #5 I2C2_SDA #1	LES_CH14 PRS_CH0 #2 ACMP3_O #2
PA2	BUSBY BUSAX LCD_SEG15	EBI_AD11 #0 EBI_DTEN #3	TIM0_CC2 #0 TIM3_CC2 #4	ETH_RMIIRXD0 #0 ETH_MIITXD2 #0 SDIO_DAT2 #1 US1_RX #6 US3_CLK #0 QSPI0_DQ0 #1	CMU_CLK0 #0 PRS_CH8 #1 ETM_TD0 #3
PG0	BUSACMP2Y BUSACMP2X	EBI_AD00 #2	TIM6_CC0 #0 TIM2_CDTI0 #3 WTIM0_CDTI1 #1 LETIM1_OUT0 #6	ETH_MIITXCLK #1 US3_TX #4 QSPI0_SCLK #2	CMU_CLK2 #3

GPIO Name	Pin Alternate Functionality / Description				
	Analog	EBI	Timers	Communication	Other
PD4	BUSADC0Y BUSADC0X OPA2_P	EBI_A08 #1 EBI_A17 #3	TIM6_CC0 #7 WTIM0_CDTI0 #4 WTIM1_CC2 #1 WTIM2_CC1 #5	CAN1_TX #2 US1_CTS #1 US3_CLK #2 LEU0_TX #0 I2C1_SDA #3	CMU_CLKI0 #0 PRS_CH10 #2 ETM_TD2 #0 ETM_TD2 #2
PC0	VDAC0_OUT0ALT / OPA0_OUTALT #0 BUSACMP0Y BUSACMP0X	EBI_AD07 #1 EBI_CS0 #2 EBI_REn #3 EBI_A23 #0	TIM0_CC1 #3 TIM2_CC1 #4 PCNT0_S0IN #2	ETH_MDIO #2 CAN0_RX #0 US0_TX #5 US1_TX #0 US1_CS #4 US2_RTS #0 US3_CS #3 I2C0_SDA #4	LES_CH0 PRS_CH2 #0
PC1	VDAC0_OUT0ALT / OPA0_OUTALT #1 BUSACMP0Y BUSACMP0X	EBI_AD08 #1 EBI_CS1 #2 EBI_BL0 #3 EBI_A24 #0	TIM0_CC2 #3 TIM2_CC2 #4 WTIM0_CC0 #7 PCNT0_S1IN #2	ETH_MDC #2 CAN0_TX #0 US0_RX #5 US1_TX #4 US1_RX #0 US2_CTS #0 US3_RTS #1 I2C0_SCL #4	LES_CH1 PRS_CH3 #0
PC2	VDAC0_OUT0ALT / OPA0_OUTALT #2 BUSACMP0Y BUSACMP0X	EBI_AD09 #1 EBI_CS2 #2 EBI_NANDWEn #3 EBI_A25 #0	TIM0_CDTI0 #3 TIM2_CC0 #5 WTIM0_CC1 #7 LETIM1_OUT0 #3	ETH_TSUEXTCLK #2 CAN1_RX #0 US1_RX #4 US2_TX #0	LES_CH2 PRS_CH10 #1
PA8	BUSBY BUSAX LCD_SEG36	EBI_AD14 #1 EBI_A02 #3 EBI_DCLK #0	TIM2_CC0 #0 TIM0_CC0 #6 LETIM0_OUT0 #6 PCNT1_S1IN #4	US2_RX #2 US4_RTS #0	PRS_CH8 #0
PA11	BUSAY BUSBX LCD_SEG39	EBI_CS1 #1 EBI_A05 #3 EBI_HSNC #0	WTIM2_CC2 #0 LETIM1_OUT0 #1	US2_CTS #2	PRS_CH11 #0
PA13	BUSAY BUSBX	EBI_WEn #1 EBI_NANDWEn #2 EBI_A01 #0 EBI_A07 #3	TIM0_CC2 #7 TIM2_CC1 #1 WTIM0_CDTI1 #2 WTIM2_CC1 #1 LETIM1_OUT1 #1 PCNT1_S1IN #5	CAN1_TX #5 US0_CS #5 US2_TX #3	PRS_CH13 #0
PB9	BUSAY BUSBX	EBI_ALE #1 EBI_NANDREn #2 EBI_A00 #1 EBI_A03 #0 EBI_A09 #3	WTIM2_CC0 #2 LETIM0_OUT0 #7	SDIO_WP #3 CAN0_RX #3 US1_CTS #0 U1_TX #2	PRS_CH13 #1 ACMP1_O #5
PB12	BUSBY BUSAX VDAC0_OUT1 / OPA1_OUT	EBI_A03 #1 EBI_A12 #3 EBI_CSTFT #2	TIM1_CC3 #3 WTIM2_CC0 #3 LETIM0_OUT1 #1 PCNT0_S0IN #7 PCNT1_S1IN #6	US2_CTS #1 US5_RTS #0 U1_RTS #2 I2C1_SCL #1	PRS_CH16 #1
PH2	BUSADC1Y BUSADC1X	EBI_VSNC #2	TIM6_CC0 #3	US1_CTS #6	
PH5	BUSADC1Y BUSADC1X	EBI_A17 #2	TIM6_CDTI0 #3 WTIM2_CC1 #6	US4_RX #4	
PH8	BUSACMP3Y BUSACMP3X	EBI_A20 #2	TIM6_CC0 #4 WTIM1_CC0 #6 WTIM2_CC1 #7	US4_CTS #4	

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
EBI_CS1	0: PD10 1: PA11 2: PC1 3: PB1	4: PE9	External Bus Interface (EBI) Chip Select output 1.
EBI_CS2	0: PD11 1: PA12 2: PC2 3: PB2	4: PE10	External Bus Interface (EBI) Chip Select output 2.
EBI_CS3	0: PD12 1: PB15 2: PC3 3: PB3	4: PE11	External Bus Interface (EBI) Chip Select output 3.
EBI_CSTFT	0: PA7 1: PF6 2: PB12 3: PA0		External Bus Interface (EBI) Chip Select output TFT.
EBI_DCLK	0: PA8 1: PF7 2: PH0 3: PA1		External Bus Interface (EBI) TFT Dot Clock pin.
EBI_DTEN	0: PA9 1: PD9 2: PH1 3: PA2		External Bus Interface (EBI) TFT Data Enable pin.
EBI_HSNC	0: PA11 1: PD11 2: PH3 3: PA4		External Bus Interface (EBI) TFT Horizontal Synchronization pin.
EBI_NANDREn	0: PC3 1: PD15 2: PB9 3: PC4	4: PC15 5: PF12	External Bus Interface (EBI) NAND Read Enable output.
EBI_NANDWEn	0: PC5 1: PD14 2: PA13 3: PC2	4: PC14 5: PF11	External Bus Interface (EBI) NAND Write Enable output.
EBI_REn	0: PF5 1: PA14 2: PA12 3: PC0	4: PF9 5: PF5	External Bus Interface (EBI) Read Enable output.
EBI_VSNC	0: PA10 1: PD10 2: PH2 3: PA3		External Bus Interface (EBI) TFT Vertical Synchronization pin.
EBI_WEn	0: PF4 1: PA13 2: PC5 3: PB6	4: PF8 5: PF4	External Bus Interface (EBI) Write Enable output.
ETH_MDC	0: PB4 1: PD14 2: PC1 3: PA6		Ethernet Management Data Clock.

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
LCD_SEG7	0: PE11		LCD segment line 7.
LCD_SEG8	0: PE12		LCD segment line 8.
LCD_SEG9	0: PE13		LCD segment line 9.
LCD_SEG10	0: PE14		LCD segment line 10.
LCD_SEG11	0: PE15		LCD segment line 11.
LCD_SEG12	0: PA15		LCD segment line 12.
LCD_SEG13	0: PA0		LCD segment line 13.
LCD_SEG14	0: PA1		LCD segment line 14.
LCD_SEG15	0: PA2		LCD segment line 15.
LCD_SEG16	0: PA3		LCD segment line 16.
LCD_SEG17	0: PA4		LCD segment line 17.
LCD_SEG18	0: PA5		LCD segment line 18.
LCD_SEG19	0: PA6		LCD segment line 19.

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
LCD_SEG33	0: PB1		LCD segment line 33.
LCD_SEG34	0: PB2		LCD segment line 34.
LCD_SEG35	0: PA7		LCD segment line 35.
LCD_SEG36	0: PA8		LCD segment line 36.
LCD_SEG37	0: PA9		LCD segment line 37.
LCD_SEG38	0: PA10		LCD segment line 38.
LCD_SEG39	0: PA11		LCD segment line 39.
LES_ALTEX0	0: PD6		LESENSE alternate excite output 0.
LES_ALTEX1	0: PD7		LESENSE alternate excite output 1.
LES_ALTEX2	0: PA3		LESENSE alternate excite output 2.
LES_ALTEX3	0: PA4		LESENSE alternate excite output 3.
LES_ALTEX4	0: PA5		LESENSE alternate excite output 4.
LES_ALTEX5	0: PE11		LESENSE alternate excite output 5.

Alternate Functionality	Location	Priority
QSPI0_DQS	0: PF9	High Speed
QSPI0_SCLK	0: PF6	High Speed
SDIO_CLK	0: PE13	High Speed
SDIO_CMD	0: PE12	High Speed
SDIO_DAT0	0: PE11	High Speed
SDIO_DAT1	0: PE10	High Speed
SDIO_DAT2	0: PE9	High Speed
SDIO_DAT3	0: PE8	High Speed
SDIO_DAT4	0: PD12	High Speed
SDIO_DAT5	0: PD11	High Speed
SDIO_DAT6	0: PD10	High Speed
SDIO_DAT7	0: PD9	High Speed
TIM0_CC0	3: PB6	Non-interference
TIM0_CC1	3: PC0	Non-interference
TIM0_CC2	3: PC1	Non-interference
TIM0_CDTI0	1: PC13	Non-interference
TIM0_CDTI1	1: PC14	Non-interference
TIM0_CDTI2	1: PC15	Non-interference
TIM2_CC0	0: PA8	Non-interference
TIM2_CC1	0: PA9	Non-interference
TIM2_CC2	0: PA10	Non-interference
TIM2_CDTI0	0: PB0	Non-interference
TIM2_CDTI1	0: PB1	Non-interference
TIM2_CDTI2	0: PB2	Non-interference
TIM4_CC0	0: PF3	Non-interference
TIM4_CC1	0: PF4	Non-interference
TIM4_CC2	0: PF12	Non-interference
TIM4_CDTI0	0: PD0	Non-interference
TIM4_CDTI1	0: PD1	Non-interference
TIM4_CDTI2	0: PD3	Non-interference
TIM6_CC0	0: PG0	Non-interference
TIM6_CC1	0: PG1	Non-interference
TIM6_CC2	0: PG2	Non-interference
TIM6_CDTI0	0: PG3	Non-interference
TIM6_CDTI1	0: PG4	Non-interference
TIM6_CDTI2	0: PG5	Non-interference

Table 5.23. ACMP0 Bus and Pin Mapping

Port	Bus	CH31	CH30	CH29	CH28	CH27	CH26	CH25	CH24	CH23	CH22	CH21	CH20	CH19	CH18	CH17	CH16	CH15	CH14	CH13	CH12	CH11	CH10	CH9	CH8	CH7	CH6	CH5	CH4	CH3	CH2	CH1	CH0
APORT0X	BUSACMP0X																									PC7	PC6	PC5	PC4	PC3	PC2	PC1	PC0
APORT0Y	BUSACMP0Y																									PC7	PC6	PC5	PC4	PC3	PC2	PC1	PC0
APORT1X	BUSAX		PB14		PB12		PB10				PB6		PB4		PB2		PB0		PA14		PA12		PA10		PA8		PA6		PA4		PA2		PA0
APORT1Y	BUSAY	PB15		PB13		PB11		PB9				PB5		PB3		PB1		PA15		PA13		PA11		PA9		PA7		PA5		PA3		PA1	
APORT2X	BUSBX	PB15		PB13		PB11		PB9				PB5		PB3		PB1		PA15		PA13		PA11		PA9		PA7		PA5		PA3		PA1	
APORT2Y	BUSBY		PB14		PB12		PB10				PB6		PB4		PB2		PB0		PA14		PA12		PA10		PA8		PA6		PA4		PA2		PA0
APORT3X	BUSCX		PF14		PF12		PF10		PF8		PF6		PF4		PF2		PF0		PE14		PE12		PE10		PE8		PE6		PE4				PE0
APORT3Y	BUSCY	PF15		PF13		PF11		PF9		PF7		PF5		PF3		PF1		PE15		PE13		PE11		PE9		PE7		PE5				PE1	
APORT4X	BUSDX	PF15		PF13		PF11		PF9		PF7		PF5		PF3		PF1		PE15		PE13		PE11		PE9		PE7		PE5				PE1	
APORT4Y	BUSDY		PF14		PF12		PF10		PF8		PF6		PF4		PF2		PF0		PE14		PE12		PE10		PE8		PE6		PE4				PE0

Table 5.29. CSEN Bus and Pin Mapping

Port	Bus	CH31	CH30	CH29	CH28	CH27	CH26	CH25	CH24	CH23	CH22	CH21	CH20	CH19	CH18	CH17	CH16	CH15	CH14	CH13	CH12	CH11	CH10	CH9	CH8	CH7	CH6	CH5	CH4	CH3	CH2	CH1	CH0
CEXT																																	
APORT1X	BUSAX		PB14		PB12		PB10				PB6		PB4		PB2		PB0		PA14		PA12		PA10		PA8		PA6		PA4		PA2		PA0
APORT1Y	BUSAY	PB15		PB13		PB11		PB9				PB5		PB3		PB1		PA15		PA13		PA11		PA9		PA7		PA5		PA3		PA1	
APORT3X	BUSCX		PF14		PF12		PF10		PF8		PF6		PF4		PF2		PF0		PE14		PE12		PE10		PE8		PE6		PE4				PE0
APORT3Y	BUSCY	PF15		PF13		PF11		PF9		PF7		PF5		PF3		PF1		PE15		PE13		PE11		PE9		PE7		PE5				PE1	
CEXT_SENSE																																	
APORT2X	BUSBX	PB15		PB13		PB11		PB9				PB5		PB3		PB1		PA15		PA13		PA11		PA9		PA7		PA5		PA3		PA1	
APORT2Y	BUSBY		PB14		PB12		PB10				PB6		PB4		PB2		PB0		PA14		PA12		PA10		PA8		PA6		PA4		PA2		PA0
APORT4X	BUSDX	PF15		PF13		PF11		PF9		PF7		PF5		PF3		PF1		PE15		PE13		PE11		PE9		PE7		PE5				PE1	
APORT4Y	BUSDY		PF14		PF12		PF10		PF8		PF6		PF4		PF2		PF0		PE14		PE12		PE10		PE8		PE6		PE4				PE0

Table 5.30. IDAC0 Bus and Pin Mapping

Port	Bus	CH31	CH30	CH29	CH28	CH27	CH26	CH25	CH24	CH23	CH22	CH21	CH20	CH19	CH18	CH17	CH16	CH15	CH14	CH13	CH12	CH11	CH10	CH9	CH8	CH7	CH6	CH5	CH4	CH3	CH2	CH1	CH0
APORT1X	BUSCX		PF14		PF12		PF10		PF8		PF6		PF4		PF2		PF0		PE14		PE12		PE10		PE8		PE6		PE4				PE0
APORT1Y	BUSCY	PF15		PF13		PF11		PF9		PF7		PF5		PF3		PF1		PE15		PE13		PE11		PE9		PE7		PE5				PE1	

8. BGA120 Package Specifications

8.1 BGA120 Package Dimensions

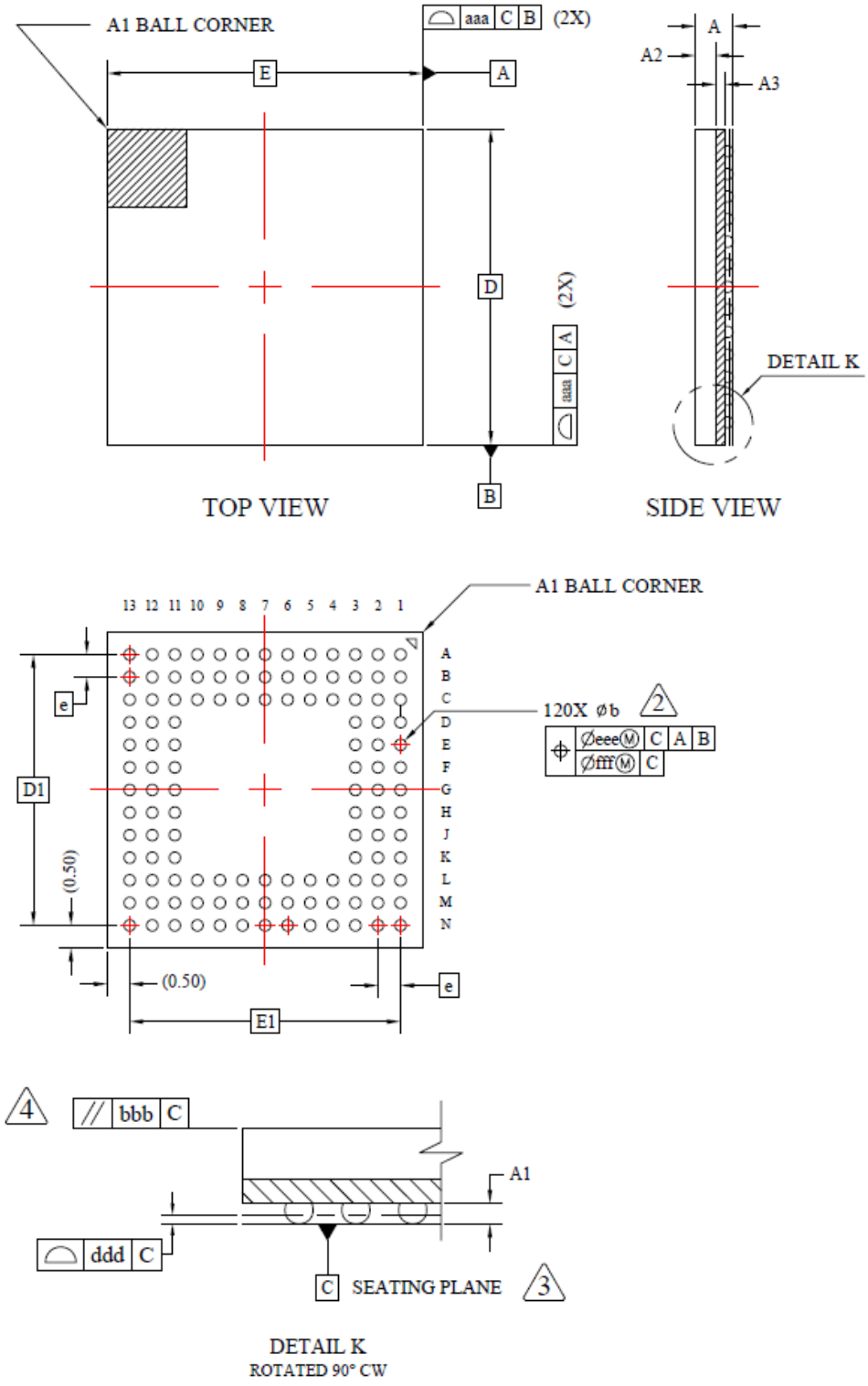

Figure 8.1. BGA120 Package Drawing

Table 11.1. TQFP64 Package Dimensions

Dimension	Min	Typ	Max
A	—	1.15	1.20
A1	0.05	—	0.15
A2	0.95	1.00	1.05
b	0.17	0.22	0.27
b1	0.17	0.20	0.23
c	0.09	—	0.20
c1	0.09	—	0.16
D	12.00 BSC		
D1	10.00 BSC		
e	0.50 BSC		
E	12.00 BSC		
E1	10.00 BSC		
L	0.45	0.60	0.75
L1	1.00 REF		
R1	0.08	—	—
R2	0.08	—	0.20
S	0.20	—	—
θ	0	3.5	7
Θ1	0	—	0.10
Θ2	11	12	13
Θ3	11	12	13

Note:

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
3. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

13. Revision History

Revision 0.6

March, 2018

- Removed "Confindential" watermark.
- Updated 4.1 Electrical Characteristics and 4.2 Typical Performance Curves with latest characterization data.

Revision 0.2

October, 2017

- Updated memory maps to latest formatting and to include all peripherals.
- Updated all electrical specifications tables with latest characterization results.
- **Absolute Maximum Ratings** Table:
  - Removed redundant I_{VSSMAX} line.
  - Added footnote to clarify V_{DIGPIN} specification for 5V tolerant GPIO.
- **General Operating Conditions** Table:
  - Removed dV_{DD} specification and redundant footnote about shorting VREGVDD and AVDD together.
  - Added footnote about IOVDD voltage restriction when CSEN peripheral is used with chopping enabled.
- **Flash Memory Characteristics** Table: Added timing measurement clarification for Device Erase and Mass Erase.
- **Analog to Digital Converter (ADC)** Table:
  - Added header text for general specification conditions.
  - Added footnote for clarification of input voltage limits.
- Minor typographical corrections, including capitalization, mis-spellings and punctuation marks, throughout document.
- Minor formatting and styling updates, including table formats, TOC location, and boilerplate information throughout document.

Revision 0.1

April 27th, 2017

Initial release.